



高速光耦

High Speed Photo Coupler

QX063X

宁波群芯微电子股份有限公司

NINGBO QUNXIN MICROELECTRONICS CO., LTD.

中国 浙江省宁波杭州湾新区玉海东路 68 号

68 Yuhaidong Road, Hangzhou Bay New District, Ningbo, Zhejiang, China

概述 Description

QX0630 QX0631 是一款双通道的高速光耦，其内部每个通道由一个 850nm 的 AlGaAs 发光二极管和一个集成检测器组成。内置屏蔽，可以保证至少 5000V/μs 的高共模抑制 (CMR) 能力。

The QX0630 QX0631 are dual-channel high-speed optocoupler that combine a 850 nm AlGaAS LED and an integrated detector. .It has built-in shielding to guarantee a high Common Mode Rejection (CMR) of at least 5,000V/μs.

特性 Features

- 高速 10 Mbit/s
High speed – 10 Mbit/s
- 卓越的 CMR : 5 kV/μs
Superior CMR : 5 kV/μs
- 输入输出之间的高隔离电压 (Viso=3750Vrms)
High isolation voltage between input and output (Viso=3750 Vrms)
- 低启动电流: 5mA
Low turn-on current: 5mA
- 工作温度: -40°C ~ +85°C
Operating Temperature: -40°C to +85°C
- 符合安规标准: UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5), CQC11-471543-2022
Meet Safety standard : UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5), CQC11-471543-2022

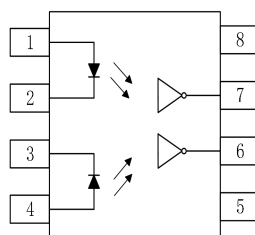
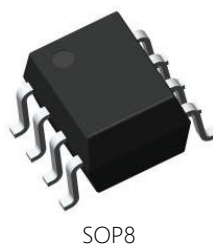
应用 Applications

- 接地回路消除
Ground loop elimination
- 开关电源
Switching power supplies
- 计算机外围接口
Computer-peripheral interface
- 数模, 模数转化中的数字隔离
Digital Isolation in D/A and A/D Conversion
- 高速逻辑系统隔离
High-speed logic system isolation

真值表 Truth table

LED	VO
OFF	H
ON	L

封装和原理图 Package and Schematic Diagram



Pin Configuration

- | | |
|--------------|--------|
| 1. Anode 1 | 8.VCC |
| 2. Cathode 1 | 7.VO 1 |
| 3. Cathode 2 | 6.VO 2 |
| 4. Anode 2 | 5.GND |

注: 在引脚 5 和 8 之间必须连接一个 0.1uF 的旁路电容器。

Note: 0.1uF bypass capacitor must be connected between pins 5 and 8.



产品型号命名规则 Order Code

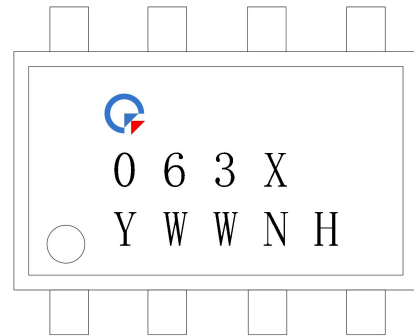
QX 063X - UN Y - W (V) (ZZ)

① ② ③ ④ ⑤ ⑥ ⑦

- ① 公司代码 Company Code (QX: 群芯 Qunxin)
- ② 产品系列 Product Series (XX: 0, 1)
- ③ 框架类型 Lead Frame (Cu: 铜框架 Copper)
- ④ 树脂类型 Epoxy Type (H: 无卤 Halogen-free)
- ⑤ 封装形式 Package (S: SOP)
- ⑥ 器件工作温度范围 Device Operating Temperature Range (特殊范围需填或者空白 Special Range need to be filled in or left blank)
- ⑦ 内部补充代码 Internal Supplementary Code (数字或者空白 Number or None)

印字信息 Marking Information

- 印字中“”为群芯品牌 LOGO
“”denotes LOGO
- 印字中的“XX”代表产品分档: 0、1
“XX”denotes the classification: 0、1
- 印字中“Y”代表年份; A(2018),B(2019),C(2020).....
“Y”denotes YEAR: A(2018), B(2019), C(2020).....
- 印字中“WW”代表周号
“WW”denotes week’s number.
- 印字中“N”代表星期几
“N”denotes day of the week.
- 印字中的“H”代表无卤
“H”denotes Halogen-free



绝缘和安规信息 Insulation and Safety related specifications

项目 Item	符号 Symbol	数值 Value	单位 Unit	备注 Remark
爬电距离 Creepage Distance	L	> 4.6	mm	从输入端到输出端，沿本体最短距离路径 Measured from input terminals to output terminals, shortest distance path along body
电气间隙 Clearance Distance	L	> 4.6	mm	从输入端到输出端，通过空气的最短距离 Measured from input terminals to output terminals, shortest distance through air
绝缘距离 Insulation Thickness	DTI	> 0.4	mm	发射器和探测器之间的绝缘厚度 Insulation thickness between emitter and detector
峰值隔离电压 Peak Isolation Voltage	V_{IORM}	600	V_{peak}	DIN/EN/DIN EN60747-5-5
瞬态隔离电压 Transient isolation voltage	V_{IOTM}	5000	V_{peak}	DIN/EN/DIN EN60747-5-5
隔离电压 Isolation Voltage	V_{iso}	> 3750	V_{rms}	For 1 min

极限参数 Absolute Maximum Ratings ($T_A=25^{\circ}C$)

参数 Parameter		符号 Symbol	额定值 Rating	单位 Unit
发射端 Input	正向电流 Forward Current	I_F	50	mA
	反向电压 Reverse Voltage	V_R	5	V
	输入功耗 Input Power Dissipation	P_I	27	mW
接收端 Output	电源电压 Supply Voltage	V_{CC}	7	V
	输出电流 Output Current	I_O	50	mA
	输出电压 Output Voltage	V_O	7	V
	输出集电极功耗 Output Collector Power Dissipation	P_O	60	mW
工作温度 Operating Temperature		T_{opr}	-40 to +85	$^{\circ}C$
存储温度 Storage Temperature		T_{stg}	-55 to +125	$^{\circ}C$
焊接温度 Soldering Temperature		T_{sol}	260	$^{\circ}C$

推荐工作条件 Recommended Operating Conditions

参数 Parameter	符号 Symbol	最小值 Min.	最大值 Max.	单位 Unit
低电平输入电流 Input Current, Low Level	I_{FL}	0	250	μA
高电平输入电流 * Input Current, High Level *	I_{FH}	5	15	mA
电源电压 Supply Voltage	V_{CC}	3	5.5	V
工作温度 Output Pull-up resistor	T_A	-40	+85	$^{\circ}C$
输出上拉电阻 Operating Temperature	R_L	330	4K	Ω

注 *：初始切换阈值为 5mA 或以下。建议使用 6.3mA 至 10mA 以达到最佳性能

Note *: The initial switching threshold is 5 mA or less. From 6.3 mA to 10 mA is recommended to achieve optimal performance

产品特性参数 Electro-optical Characteristics ($T_A=25^\circ\text{C}$)

参数 Parameter		符号 Symbol	条件 Condition	最小 Min.	典型 Typ.	最大 Max.	单位 Unit
发射端 Input	正向电压 Forward Voltage	V_F	$I_F=10\text{mA}$	1.2	1.35	1.8	V
	反向击穿电压 Reverse Breakdown Voltage	B_{VR}	$I_R=10\mu\text{A}$	5	-	-	V
	输入电容 Input Capacitance	C_{IN}	$V=0, f=1\text{MHz}$	-	60	-	pF
接收端 Output	高电平电源电流 High Level Supply Current	I_{CCH}	$I_F=0\text{mA}, V_{CC}=5.5\text{V}$	-	10	15	mA
	低电平电源电流 Low Level Supply Current	I_{CCL}	$I_F=10\text{mA}, V_{CC}=5.5\text{V}$	-	13	21	mA
传输特性 Transfer Characteristics	高电平输出电流 High Level Output Current	I_{OH}	$I_F=250\mu\text{A}$ $V_{CC}=V_O=5.5\text{V}$	-	5.5	100	μA
	低电平输出电压 Low Level Output Voltage	V_{OL}	$I_F=5\text{mA}, V_{CC}=5.5\text{V}$ $I_{OL}=13\text{mA}$	-	0.35	0.6	V
	输入阈值电流 Input Threshold Current	I_{FT}	$V_{CC}=5.5\text{V}, I_{OL}=13\text{mA}$ $V_O<0.6\text{V}$	-	2.5	5	mA
隔离电压 Isolation Voltage		V_{ISO}	$R_H<50\%$ $I_{I-O}\leq 50\mu\text{A}$	3750	-	-	V_{RMS}
隔离电阻 ^① Isolation Resistance		R_{I-O}	$V_{I-I}=500\text{V}$, 40~60%R.H.	-	10^{12}	-	Ω
隔离电容 ^① Isolation Capacitance		C_{I-O}	$V=0, f=1\text{MHz}$	-	0.6	-	pF
输入隔离电阻 ^② Input Isolation Resistance		R_{I-I}	$V_{I-I}=500\text{V}$, 40~60%R.H.	-	10^{11}	-	Ω
输入隔离电容 ^② Input Isolation Capacitance		C_{I-I}	$V=0, f=1\text{MHz}$	-	0.25	-	pF

注: Note:

1. 测量时将 PIN1,2,3,4 短接, PIN5,6,7,8 短接。
When measuring, short-circuit PIN1, 2, 3, and 4, and short-circuit PIN5, 6, 7, and 8.
2. 测量时将 PIN1,2 短接, PIN3,4 短接。
When measuring, short-circuit PIN1, 2, and short-circuit PIN3, 4.

开关特性 Switching Specification ($T_A=25^\circ\text{C}$)

参数 Parameter	符号 Symbol	条件 Condition	最小 Min.	典型 Typ.	最大 Max.	单位 Unit
输出高电平传播延迟 Propagation Delay Time to Output High Level	T_{PLH}	$I_F=7.5\text{mA}$ $V_{CC}=5.0\text{V}$ $C_L=15\text{pF}$ $R_L=350\Omega$	20	48	75	ns
输出低电平传播延迟 Propagation Delay Time to Output Low Level	T_{PHL}		25	50	75	ns
脉宽失真 ($ T_{PHL}-T_{PLH} $) Pulse Width Distortion ($ T_{PHL}-T_{PLH} $)	PWD		-	3.5	35	ns
输出上升时间(10% - 90%) Output Rise Time (10 to 90%)	t_r		-	24	-	ns
输出下降时间(90% - 10%) Output Fall Time (90 to 10%)	t_f		-	10	-	ns
传播延迟偏斜 Propagation Delay Skew	t_{psk}		-	-	40	ns
输出高电平共模瞬态抑制 Common Mode Transient Immunity at Output High Level	0630	$I_F=0\text{mA}$ $V_{CC}=5.0\text{V}$ $ V_{CM} =1000\text{V(Peak)}$ $V_{O(MIN)}=2\text{V}$ $R_L=350\Omega$	5	-	-	kV/ μs
	0631		10	-	-	
输出低电平共模瞬态抑制 Common Mode Transient Immunity at Output Low Level	0630	$I_F=7.5\text{mA}$ $V_{CC}=5.0\text{V}$ $ V_{CM} =1000\text{V(Peak)}$ $V_{O(MAX)}=0.8\text{V}$ $R_L=350\Omega$	5	-	-	kV/ μs
	0631		10	-	-	

典型光电特性曲线 Typical Electro-Optical Characteristics Curves

Fig.1 Low-level output voltage vs. Ambient temperature

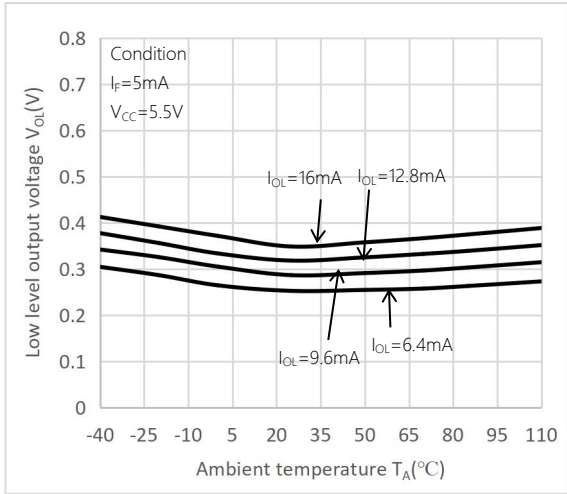


Fig.2 Forward current vs. Forward voltage

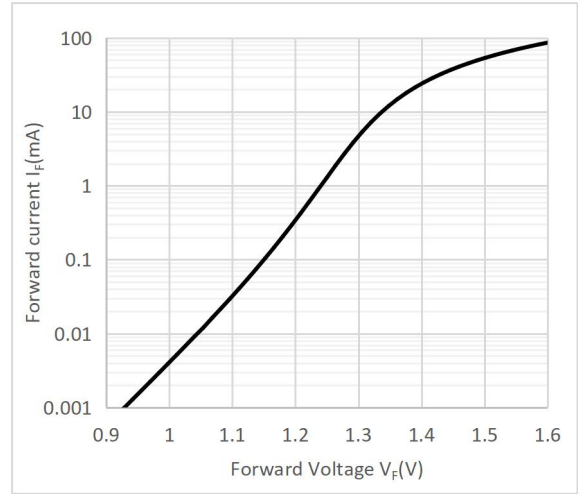


Fig.3 Propagation delay time vs. Forward current

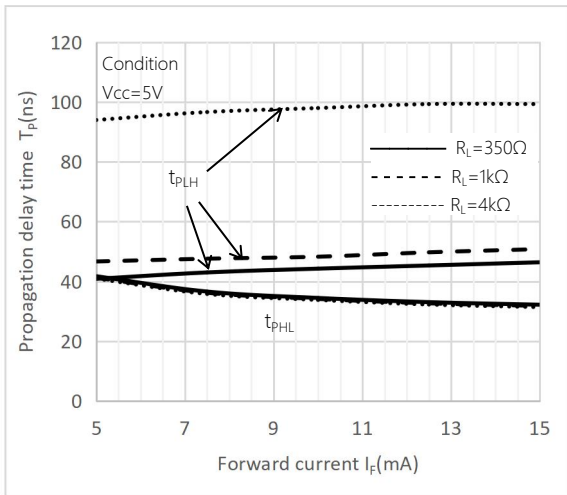


Fig.4 Low-level output current vs. Ambient temperature

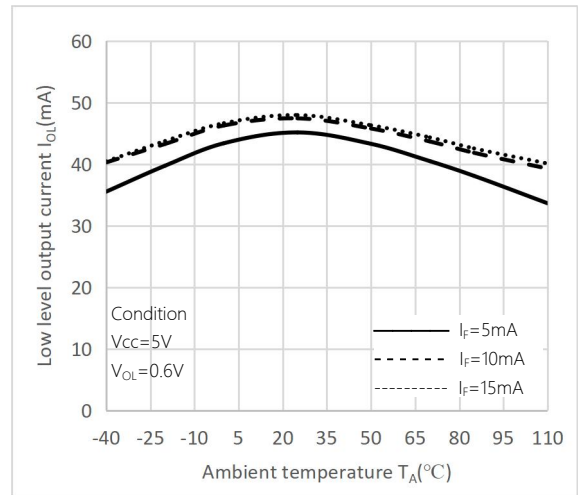


Fig.5 Input threshold current vs. Ambient temperature

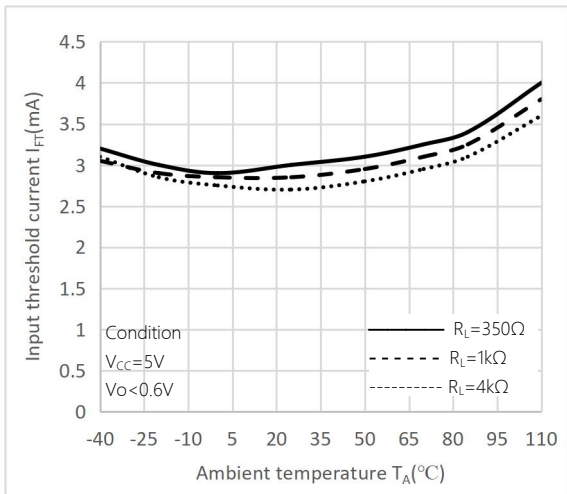


Fig.6 Output voltage vs. Forward current

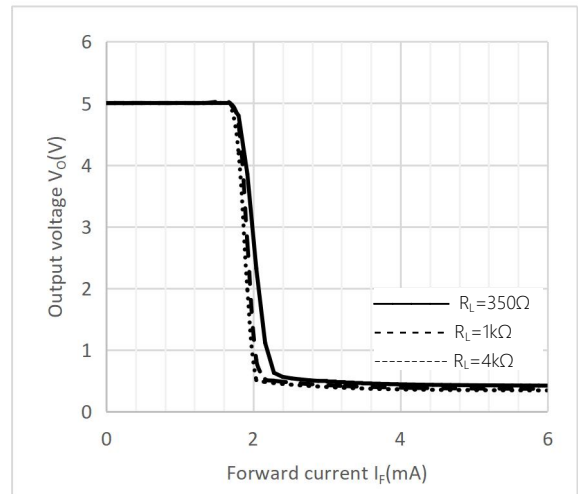


Fig.7 Pulse-width distortion vs. Ambient temperature

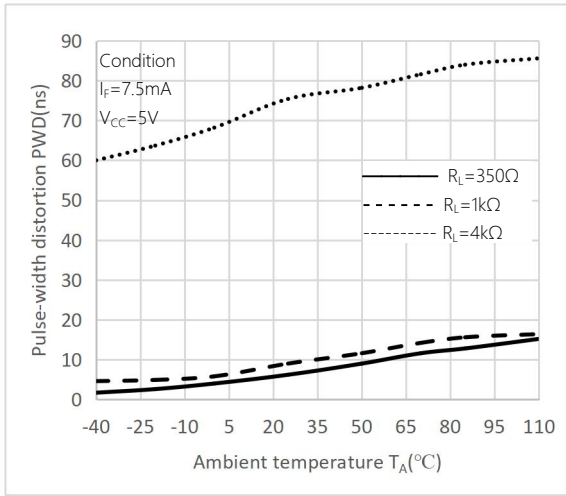


Fig.8 Switching time vs. Ambient temperature

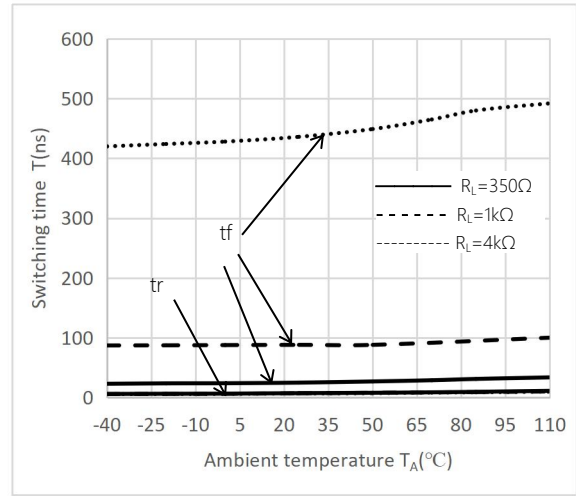


Fig.9 Propagation delay time vs. Ambient temperature

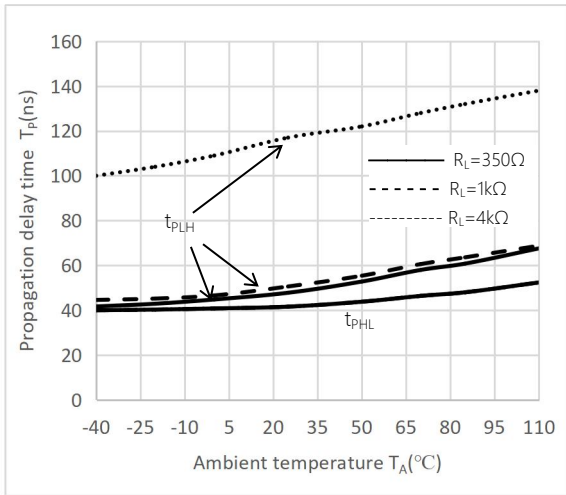
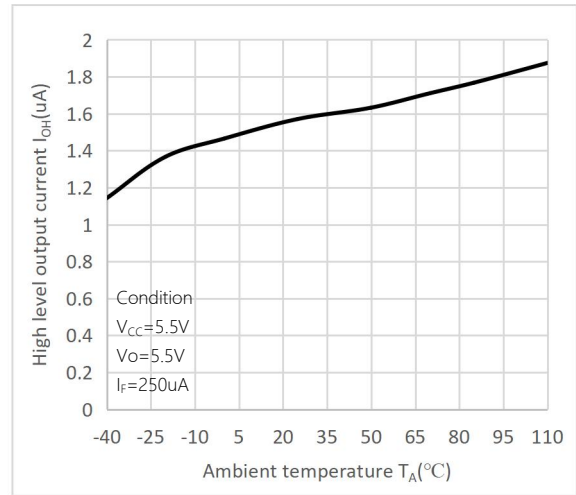
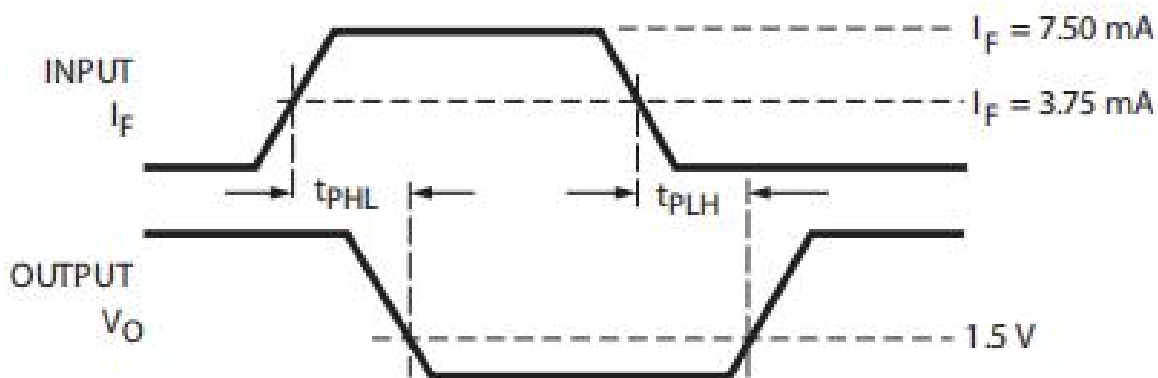
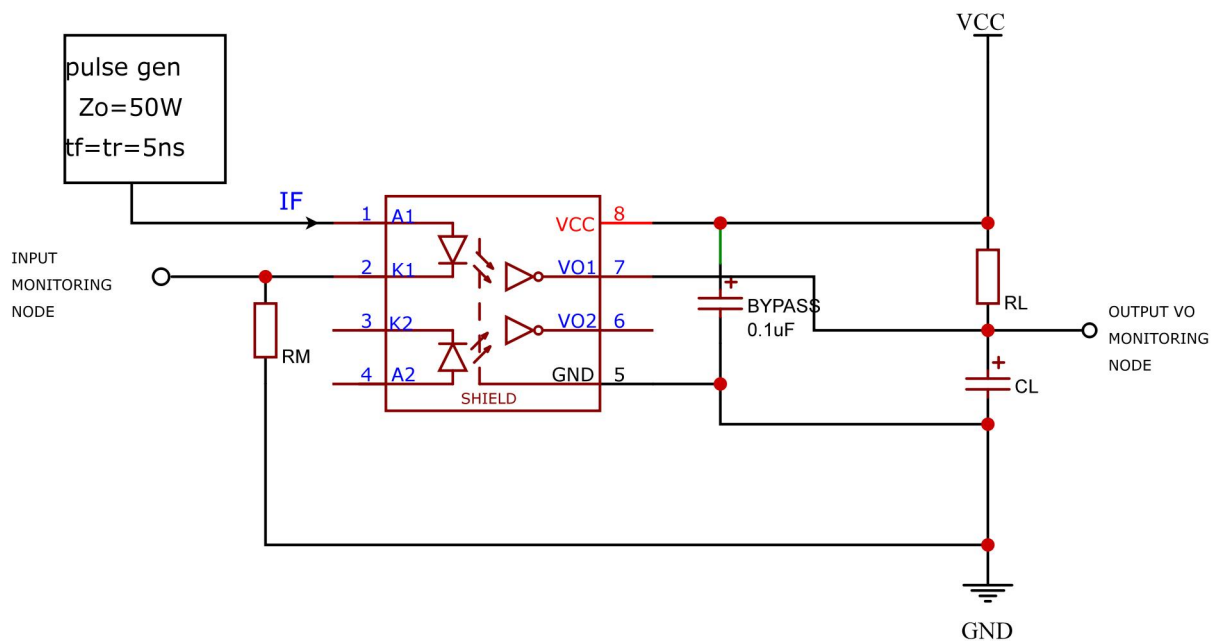


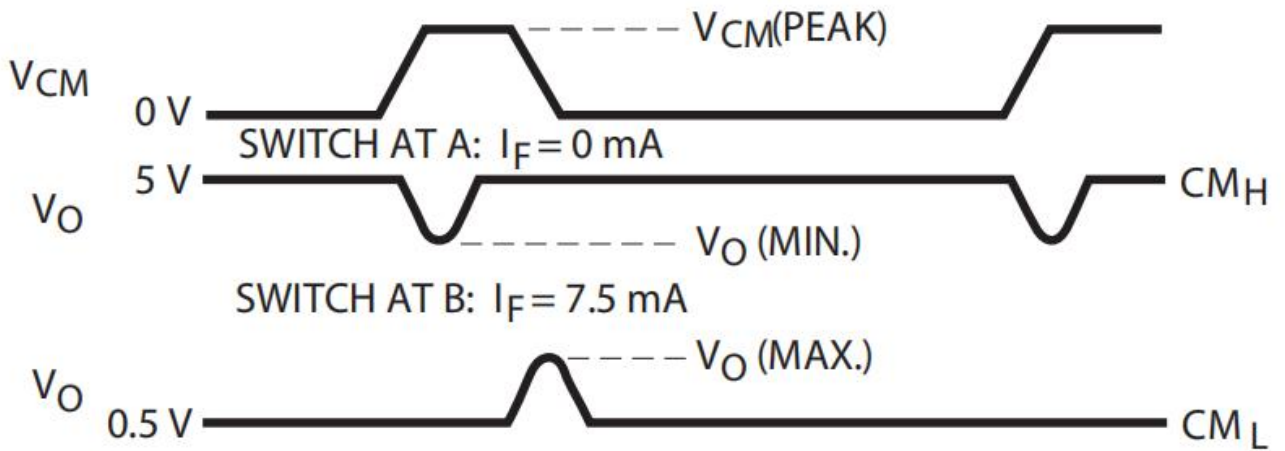
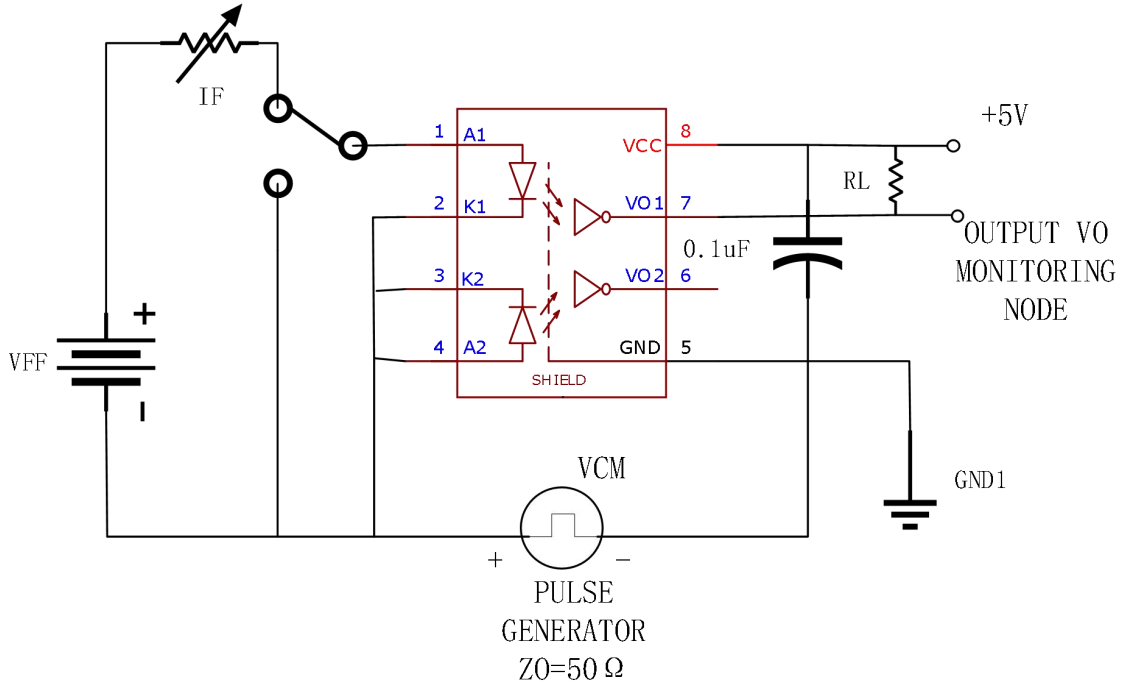
Fig.10 High-level output current vs. Ambient temperature



传输延迟时间测试电路 Test Circuit for Propagation Delay Time

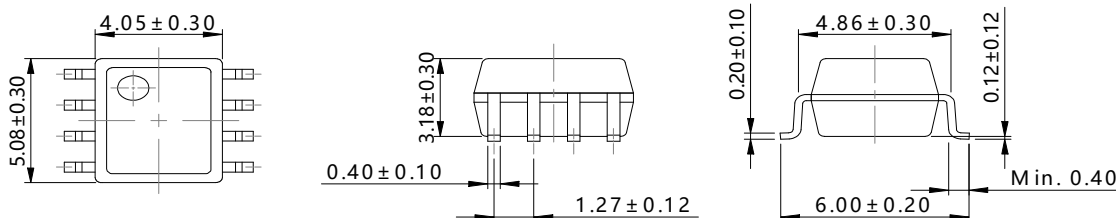


CMR 测试电路 Test Circuit for Common Mode Transient Immunity



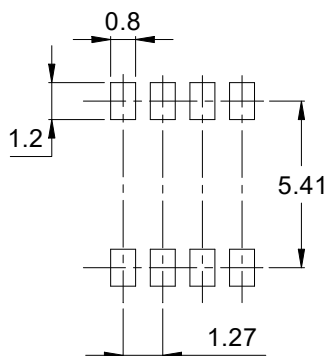
外形尺寸 Outline Dimensions

SOP8



单位 Unit: mm

建议焊盘布局 Recommended Pad Layout

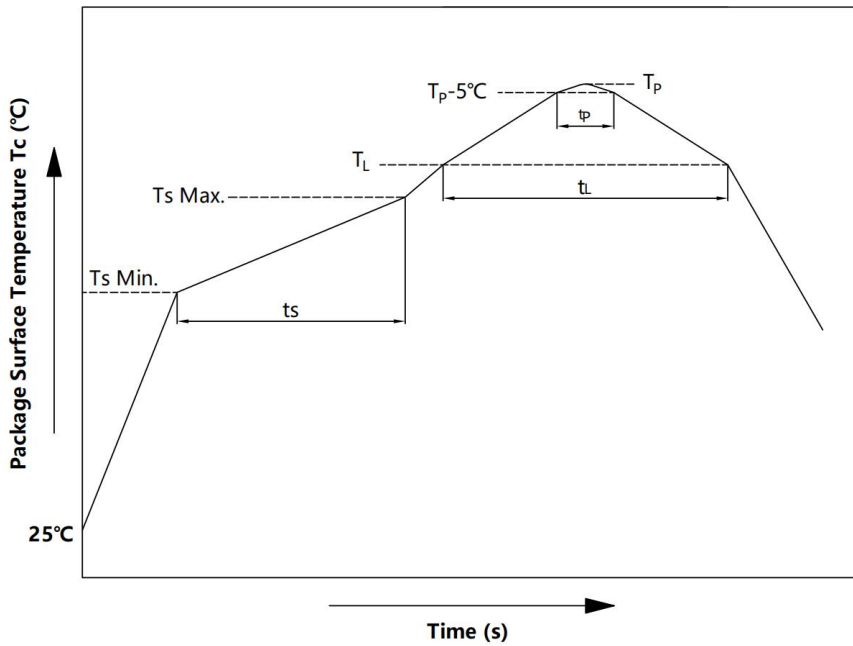


单位 Unit: mm

注：上图为产品正视图。

Note: The picture above is the front view of the product.

回流焊温度曲线图 Solder Reflow Profile



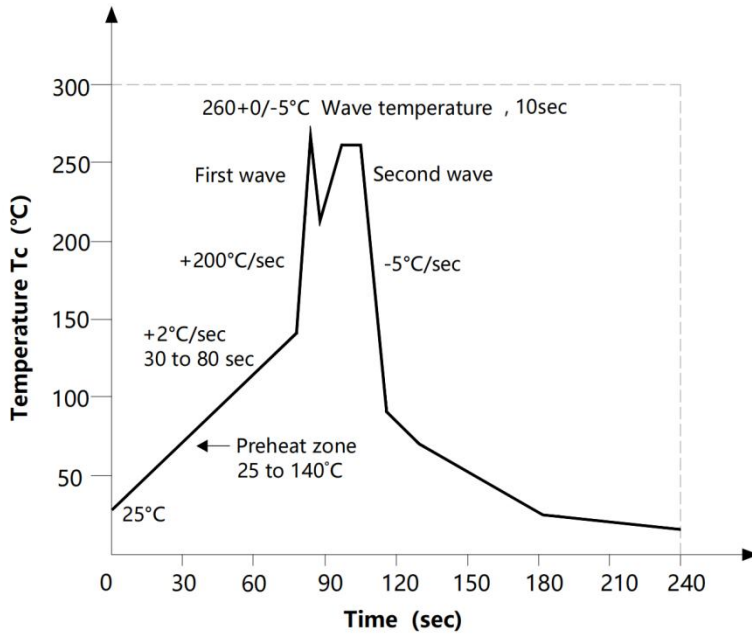
项目 Item	符号 Symbol	最小值 Min.	最大值 Max.	单位 Unit
预热温度 Preheat Temperature	T_s	150	200	$^\circ\text{C}$
预热时间 Preheat Time	t_s	60	120	s
升温速率 Ramp-Up Rate (T_L to T_P)	-	-	3	$^\circ\text{C}/\text{s}$
液相线温度 Liquidus Temperature	T_L	217		$^\circ\text{C}$
时间高于 T_L Time Above T_L	t_L	60	150	s
峰值温度 Peak Temperature	T_P	-	260	$^\circ\text{C}$
T_c 在 (T_P-5) 和 T_P 之间的时间 Time During Which T_c Is Between (T_P-5) and T_P	t_p	-	30	s
降温速率 Ramp-down Rate (T_P to T_L)	-	-	6	$^\circ\text{C}/\text{s}$

注 Note:

建议在所示的温度和时间条件下进行回流焊，最多不能超过三次；

Reflow soldering is recommended at the temperatures and times shown, no more than three times;

波峰焊温度曲线图 Wave Soldering Profile



手工烙铁焊接 Soldering with hand soldering iron

- A. 手工烙铁焊仅用于产品返修或样品测试;
Hand soldering iron is only used for product rework or sample testing;
- B. 手工烙铁焊要求: 温度 $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, 时间 $\leq 3\text{s}$.
Hand soldering iron requirements: Temperature: $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, within 3s.

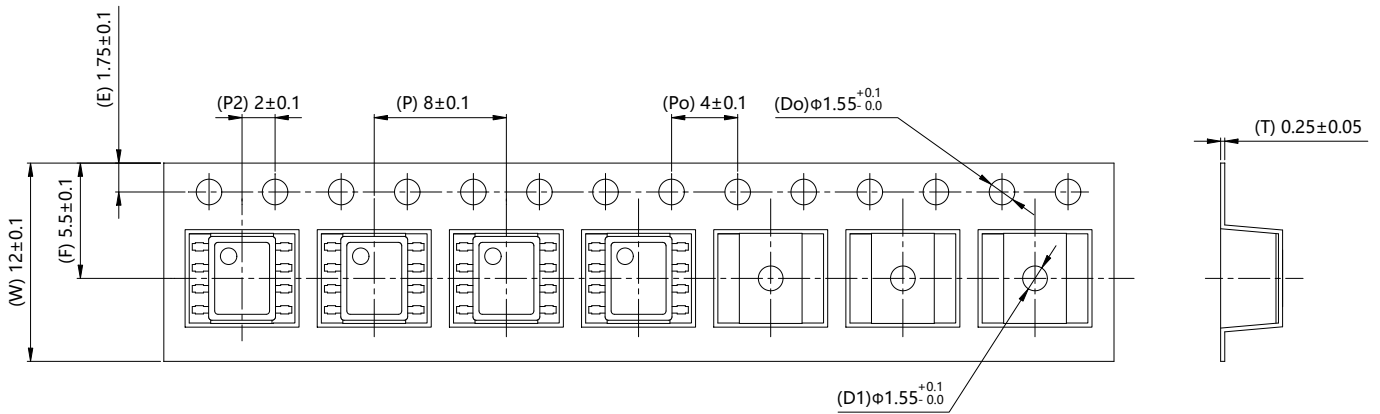
包装 Packing

■ 汇总表 Summary table

封装形式	包装方式	盘数量	盒数量	箱数量	静电袋规格	盒规格	箱(双瓦楞)规格	备注
SOP8	编带 (φ330mm 蓝盘)	2k /盘	2 盘/盒	10 盒/箱	450*390*0.1mm	353*340*60mm	650*375*365mm	首端各空 50 个 空格, 末端空 100
Package Type	Packing Form	Quantity per Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
SOP8	Reel (φ330mm Blue)	2k pcs/reel	2 reels /box	10 boxes /ctn	450*390*0.1mm	353*340*60mm	650*375*365mm	Leave 50 spaces at the beginning and 100 spaces at the end

■ 编带包装 Tape & Reel

- 1) 每卷数量: 2000 只。
Qty/reel: 2000 pcs.
- 2) 每箱数量: 40000 只。
Qty/ctn: 40000 pcs.
- 3) 内包装: 每盒 2 盘。
Inner packing: 2reels/box
- 4) 示意图 Schematic:



单位 Unit: mm

注意 Attention

- 群芯持续不断改进质量、可靠性、功能或设计，保留此文件更改的权利恕不另行通知。
QUNXIN continuously improve quality, reliability, function and design. We reserve the right to change this document without prior notice.
- 请遵守产品规格书使用，群芯不对使用时不符合产品规格书条件而导致的质量问题负责。
Please use in accordance with the product specification. QUNXIN is not responsible for the quality problems caused by non-compliance with the product specifications.
- 对于需要高可靠性或安全性的设备/装置需求，请联系我们的销售人员。
For equipment/devices requiring high reliability or safety, please contact our sales representatives.
- 当需要用于任何“特定”应用时，请咨询我们的销售人员。
When requiring a device for any “specific” application, please contact our sales in advice.
- 如对文件中表述的内容有疑问，欢迎联系我们。
If you have any questions about the contents of the document, please contact us.